1-746611-0 ACTIVE

AMP-LATCH

TE Internal #: 1-746611-0

Wire-to-Board, 20 Position, 2.54 mm [.1 in] Centerline, Vertical,

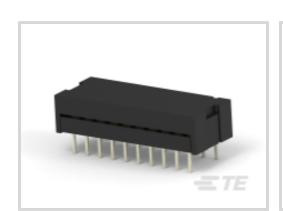
Through Hole - Solder, 2 Row, Plug, Standard Profile, Ribbon Cable

Connectors

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors











Connector System: Wire-to-Board

Number of Positions: 20

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

Features

Product Type Features

Connector Product Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable
Configuration Features	
Number of Positions	20
PCB Mount Orientation	Vertical
Number of Rows	2
Electrical Characteristics	
Operating Voltage	250 VAC
Insulation Resistance	5000 ΜΩ

Body Features

Daisy Chain	Without	



Primary Product Color	Black
Connector Profile	Standard
Contact Features	
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Wire Contact Termination Area Plating Material	Gold
PCB Contact Termination Area Plating Material Thickness	.762 μm[30 μin]
Contact Layout	Inline
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Gold
Wire Contact Termination Area Plating Thickness	.127 μm[5 μin]
Contact Type	Pin
Contact Current Rating (Max)	1 A
ermination Features	
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]
Termination Method to Wire & Cable	Insulation Displacement (IDC)
Termination Post & Tail Length	3.94 mm[.155 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Panel Mount Feature	Without
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment Type	Polarization
Mating Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Compatible Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]
Connector Width	10.67 mm[.42 in]



Wire Size	30 – 26 AWG
PCB Thickness (Recommended)	3.18 mm[.125 in]
Connector Height	6.43 mm[.253 in]
Connector Length	27.64 mm[1.088 in]
Row-to-Row Spacing	2 mm[.3 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
Compatible With Agency/Standards Products	CSA, UL
UL Rating	Recognized
UL Flammability Rating	UL 94V-0
Compatible With Approved Standards Products	CSA LR7189, UL E28476
Packaging Features	
Packaging Quantity	120

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Box & Tray, Tray

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Customers Also Bought

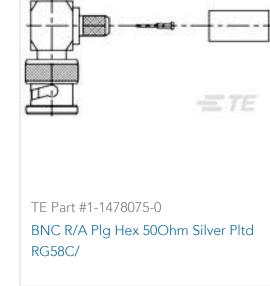




















Documents

Product Drawings
20 DIP PLUG CONN-W/COVER

English

CAD Files

3D PDF

3D



Customer View Model

ENG_CVM_CVM_1-746611-0_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-746611-0_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-746611-0_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

Ribbon Cable Interconnect Solutions

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

UL Report

English